## GaAs SPDT Switch

DC - 6.0 GHz

#### Features

- Low Insertion Loss: 0.5 dB Typical @ 4 GHz
- Fast Switching Speed: 4 ns Typical
- Ultra Low DC Power Consumption

#### Description

M/A-COM Technology's MASW6010G is an SPDT GaAs MESFET MMIC. This part combines small size, low insertion loss and power consumption with high isolation. Ideal for many applications and module use. It will function well for designs below 6 GHz.

This die includes full passivation for performance and reliability.

### Ordering Information<sup>1</sup>

Part Number	er Package	
MASW6010G	Die	

1. Die quantity varies.

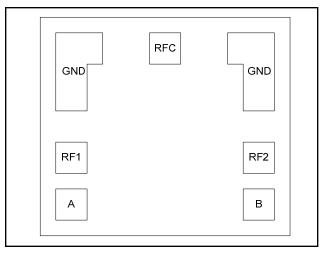
1

#### Absolute Maximum Ratings<sup>2</sup>

Parameter	Absolute Maximum		
Control Voltage (A/B)	-8.5 VDC		
Input RF Power	+34 dBm (500 MHz - 6 GHz)		
Operating Temperature	+175°C		
Storage Temperature	-65°C to +175°C		

2. Exceeding any one or combination of these limits may cause permanent damage to this device.

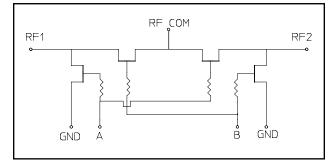
### Pad Layout



#### Bond Pad Dimensions

Bond Pad	Dimension Inches (mm)		
RFC	0.004 x 0.004 (0.100 x 0.100)		
RF2, RF3	0.004 x 0.004 (0.100 x 0.100)		
А, В	0.004 x 0.004 (0.100 x 0.100)		
GND1, GND2	0.012 x 0.004 (0.300 x 0.100)		
DIE Size	0.031 x 0.031 x 0.010 (0.80 x 0.80 x 0.25)		

#### Schematic



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### Electrical Specifications <sup>3,4</sup>: $T_A = 25^{\circ}C$ , $Z_0 = 50 \Omega$

Parameter	Test Conditions Units		Min.	Тур.	Max.
Insertion Loss	DC - 1.0 GHz         —           DC - 2.0 GHz         dB         —           DC - 6.0 GHz         —         —				0.6 0.8 1.4
Isolation	DC - 1.0 GHz DC - 2.0 GHz dB DC - 6.0 GHz		45 38 22		
VSWR	DC - 1.0 GHz DC - 2.0 GHz DC - 6.0 GHz				1.1:1 1.2:1 1.9:1
Trise, Tfall	10% to 90% RF and 90% to 10% RF ns		_	2	_
Ton, Toff	50% control to 90% RF, and 50% control to 10% RF ns		_	4	_
Transients	In-Band	mV		10	
Input P1dB	Above 500 MHz, 0 to -5 V 100 MHz, 0 to -5 V Above 500 MHz, 0 to -8 V 100 MHz, 0 to -8 V			+27 +21 +33 +26	
IP2	Two Tone, +5 dBm/Tone, 5 MHz Spacing Above 500 MHz 100 MHz dBm			+68 +62	—
IIP3	Two Tone, +5 dBm/Tone, 5 MHz Spacing Above 500 MHz 100 MHz dE		_	+46 +40	—
Control Voltage (Complementary Logic)	V <sub>IN</sub> Low, 0 to -0.2 V V <sub>IN</sub> High, -5 V V <sub>IN</sub> High, -8 V				20 50 300

3. All specifications apply with 50-ohm impedance connected to all RF ports, 0 and -8 VDC control voltages.

4. Loss changes 0.0025 dB/°C (From –55°C to +85°C).

#### **Handling Procedures**

Please observe the following precautions to avoid damage:

#### **Static Sensitivity**

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

#### Truth Table <sup>5</sup>

Control Inputs		Condition of Switch RF Common to each RF Por	
Α	В	RF1	RF2
V <sub>IN</sub> Hi	V <sub>IN</sub> Low	On	Off
V <sub>IN</sub> Low	V <sub>IN</sub> Hi	Off	On

5.  $V_{IN}$  Low = 0 to -0.2 V,  $V_{IN}$  High = -5 to -8 V.

2

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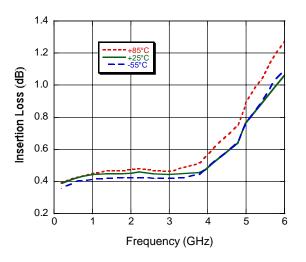
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#### **Typical Performance Curves**

#### Insertion Loss

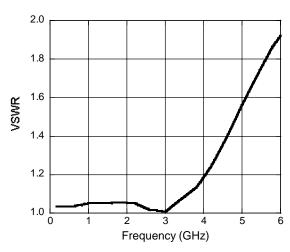


80 70 Isolation (dB) 60 50 40 30 20 0 1 2 3 4 5 6 Frequency (GHz)

Isolation

#### VSWR

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#### **Handling Procedures**

Permanent damage to the MASW6010G may occur if the following precautions are not adhered to:

- A. Cleanliness The MASW6010G should be handled in a clean environment. DO NOT attempt to clean assembly after the MASW6010G is installed.
- B. Static Sensitivity All die handling equipment and personnel should be DC grounded.
- C. Transients Avoid instrument and power supply transients while bias is connected to the MASW6010G. Use shielded signal and bias cables to minimize inductive pick-up.
- D. Bias Apply voltage to either control port A/B or only when the other is grounded. Neither port should be allowed to "float".
- E. General Handling It is recommended that the MASW6010G chip be handled along the long side of the die with a sharp pair of bent tweezers. DO NOT touch the surface of the chip with fingers or tweezers.

#### Mounting

The MASW6010G is back-metalized with Pd/Ni/Au (100/1,000/30,000Å) metallization. It can be die-mounted using Au/Sn eutectic preforms or a thermally conductive epoxy. The package surface should be clean and flat before attachment.

#### Eutectic Die Attach:

- A. An 80/20 Au/Sn preform is recommended with a work surface temperature of approximately 255°C and a tool temperature of 265°C. When hot 90/10 nitrogen/hydrogen gas is applied, solder temperature should be approximately 290°C.
- B. DO NOT expose the MASW6010G to a temperature greater than 320°C for more than 20 seconds. No more than 3 seconds of scrubbing should be required for attachment.

#### Epoxy Die Attach:

Δ

- A. Electrically conductive epoxy must be used.
- B. Apply a minimum amount of epoxy and place the MASW6010G into position. A thin epoxy fillet should be visible around the perimeter of the die.
- C. Cure epoxy per manufacturer's recommended schedule.

#### Wire Bonding

- A. Ball or wedge bond with 1.0 mil diameter pure gold wire. Thermosonic wire bonding with a nominal stage temperature of 150°C and a ball bonding force of 40 to 50 grams or wedge bonding force of 18 to 22 grams is recommended. Ultrasonic energy and time should be adjusted to the minimum levels to achieve reliable wirebonds.
- B. Wirebonds should be started on the chip and terminated on the package.

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